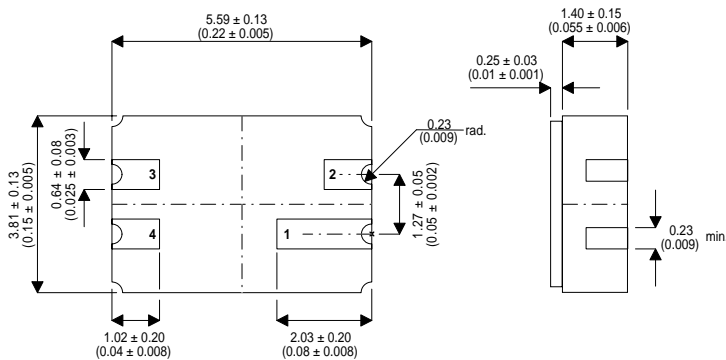


## P-CHANNEL ENHANCEMENT MODE MOSFET

### MECHANICAL DATA

Dimensions in mm (inches)



### LCC3 PACKAGE (MO-041BA) Underside View

PAD 1 - Drain      PAD 3 - Source  
PAD 2 - N/C      PAD 4 - Gate

### FEATURES

- $B_{VDSS} = -60V$
- $I_D = -2.5A$
- $R_{DS(ON)} = 0.3\Omega$
- Hermetic Surface Mount Package
- Screening Option Available

The SML2955CSM4 is a very low on state resistance P-Channel enhancement mode mosfet in a Ceramic Surface Mount package designed for high rel applications:

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$ unless otherwise stated)

$V_{DS}$	Drain – Source Voltage	-60V
$V_{GS}$	Gate – Source Voltage	±20V
$I_D$	Continuous Drain Current @ $T_A = 25^\circ C$	-2.5A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	-15A
$P_D$	Power Dissipation @ $T_A = 25^\circ C$	0.8W
	@ $T_A = 100^\circ C$	0.32W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	156°C/W
$T_{STG}, T_J$	Maximum Junction and Storage Temperature Range	-55 to +150°C

#### NOTE:

- 1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

Semelab Plc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.

**ELECTRICAL RATINGS** ( $T_A = 25^\circ\text{C}$  unless otherwise stated)

Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
<b>STATIC CHARACTERISTICS</b>					
$V_{(BR)DSS}$ Drain – Source Breakdown Voltage	$V_{GS} = 0V$ $I_D = -250\mu A$	-60			V
$V_{GS(TH)}$ Gate Threshold Voltage <sup>1</sup>	$V_{DS} = V_{GS}$ $I_D = -250\mu A$	-2.0	-2.6	-4.0	
$I_{GSS}$ Gate – Source Leakage Current	$V_{GS} = \pm 20V$ $V_{DS} = 0V$			$\pm 100$	nA
$I_{DSS}$ Zero Gate Voltage Drain Current	$V_{DS} = -60V$ $V_{GS} = 0V$			-10	$\mu A$
$I_{D(ON)}$ On State Drain Current <sup>1</sup>	$V_{DS} = -5.0V$ $V_{GS} = -10V$	-12			A
$R_{DS(ON)}$ Drain Source On-State Resistance <sup>1</sup>	$I_D = -2.0A$ $V_{GS} = -4.5V$			0.55	$\Omega$
	$I_D = -2.5A$ $V_{GS} = -10V$			0.35	
	$T_J = 125^\circ\text{C}$			0.55	
$g_{fs}$ Forward Transconductance <sup>1</sup>	$V_{GS} = -10V$ $I_D = -2.5A$		5.5		S
$V_{SD}$ Diode Forward Voltage <sup>1</sup>	$V_{GS} = 0V$ $I_D = -2.5A$		-0.8	-1.2	V
<b>DYNAMIC CHARACTERISTICS</b>					
$C_{iss}$ Input capacitance	$V_{DS} = -30V$ $f = 1.0\text{MHz}$ $V_{GS} = 0V$		601		pF
$C_{oss}$ Output capacitance			85		
$C_{riss}$ Reverse transfer capacitance			35		
<b>SWITCHING CHARACTERISTICS</b>					
$Q_g$ Total Gate Charge	$V_{DS} = -30V$ $I_D = -2.5A$ $V_{GS} = -10V$		11	15	nC
$Q_{gs}$ Gate-Source Charge			2.4		
$Q_{gd}$ Gate-Drain Charge			2.7		
$t_{d(on)}$ Turn-on Delay Time	$I_D = -1.0A$ $V_{DD} = -30V$ $V_{GS} = -10V$ $R_{GEN} = 6\Omega$		12	21	ns
$t_r$ Rise Time			10	20	
$t_{d(off)}$ Turn-off Delay Time			19	34	
$t_f$ Fall Time			6	12	

**NOTES:**

 1) Pulse Test: Pulse Width =  $300\mu s$  , Duty Cycle  $\leq 2\%$